NST3904DP6T5G

Dual General Purpose Transistor

The NST3904DP6T5G device is a spin-off of our popular SOT-23/SOT-323/SOT-563 three-leaded device. It is designed for general purpose amplifier applications and is housed in the SOT-963 six-leaded surface mount package. By putting two discrete devices in one package, this device is ideal for low-power surface mount applications where board space is at a premium.

Features

- h_{FE}, 100–300
- Low $V_{CE(sat)}$, $\leq 0.4 \text{ V}$
- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- This is a Pb–Free Device

MAXIMUM RATINGS

| Rating | | Symbol | Value | Unit |
|--------------------------------|-----------|------------------|--------|------|
| Collector – Emitter Voltage | | V _{CEO} | 40 | Vdc |
| Collector - Base Voltage | | V _{CBO} | 60 | Vdc |
| Emitter – Base Voltage | | V _{EBO} | 6.0 | Vdc |
| Collector Current – Continuous | | Ι _C | 200 | mAdc |
| Electrostatic Discharge | HBM MM | ESD Class | 2 B | |

THERMAL CHARACTERISTICS

| Characteristic (Single Heated) | Symbol | Max | Unit |
|--|-----------------------------------|----------------|-------------|
| Total Device Dissipation T _A = 25°C Derate above 25°C (Note 1) | PD | 240 1.9 | mW mW/°C |
| Thermal Resistance, Junction-to-Ambient (Note 1) | $R_{	hetaJA}$ | 520 | °C/W |
| Total Device Dissipation $T_A = 25^{\circ}C$ Derate above 25°C (Note 2) | P _D | 280 2.2 | mW mW/°C |
| Thermal Resistance, Junction-to-Ambient (Note 2) | R_{\thetaJA} | 446 | °C/W |
| Characteristic (Dual Heated) (Note 3) | Symbol | Мах | Unit |
| Total Device Dissipation $T_A = 25^{\circ}C$ Derate above 25°C (Note 1) | PD | 350 2.8 | mW mW/°C |
| Thermal Resistance, Junction-to-Ambient (Note 1) | R_{\thetaJA} | 357 | °C/W |
| Total Device Dissipation $T_A = 25^{\circ}C$ Derate above 25°C (Note 2) | P _D | 420 3.4 | mW mW/°C |
| Thermal Resistance, Junction-to-Ambient (Note 2) | $R_{\theta JA}$ | 297 | °C/W |
| Junction and Storage Temperature Range | T _J , T _{stg} | –55 to +150 | °C |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-4 @ 100 mm², 1 oz. copper traces, still air.

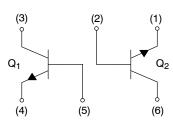
2. FR-4 @ 500 mm², 1 oz. copper traces, still air.

3. Dual heated values assume total power is sum of two equally powered channels.



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NST3904DP6T5G



MARKING DIAGRAM



E = Device Code M = Date Code = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|---------------|----------------------|-----------------------|
| NST3904DP6T5G | SOT-963 (Pb-Free) | 8000/Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

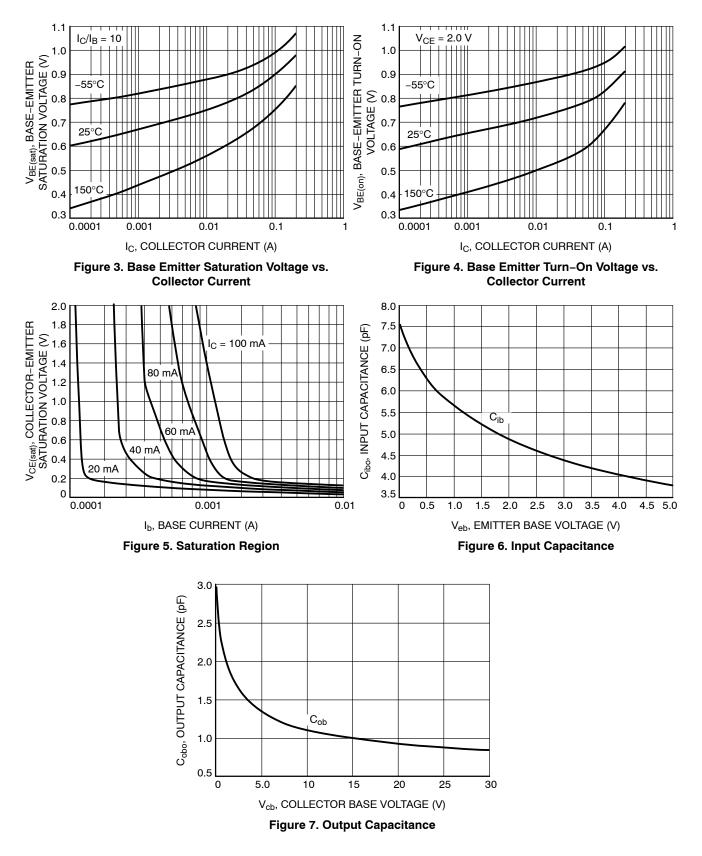
NST3904DP6T5G

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

| | Characteristic | Symbol | Min | Max | Unit | |
|--|---|-------------------------------------|--------------|------|------|--|
| OFF CHARACTERISTICS | | | | | | |
| Collector - Emitter Breakdown Vol | V _{(BR)CEO} | 40 | - | Vdc | | |
| Collector - Base Breakdown Voltag | V _{(BR)CBO} | 60 | - | Vdc | | |
| Emitter – Base Breakdown Voltage | e (I _E = 10 μAdc, I _C = 0) | V _{(BR)EBO} | 6.0 | - | Vdc | |
| Collector Cutoff Current (V _{CE} = 30 | I _{CEX} | - | 50 | nAdc | | |
| ON CHARACTERISTICS (Note 4) | | | • | • | • | |
| $ \begin{array}{l} \text{DC Current Gain} \\ (I_{C}=0.1 \text{ mAdc}, V_{CE}=1.0 \text{ Vdc} \\ (I_{C}=1.0 \text{ mAdc}, V_{CE}=1.0 \text{ Vdc} \\ (I_{C}=10 \text{ mAdc}, V_{CE}=1.0 \text{ Vdc}) \\ (I_{C}=50 \text{ mAdc}, V_{CE}=1.0 \text{ Vdc}) \\ (I_{C}=100 \text{ mAdc}, V_{CE}=1.0 \text{ Vdc}) \end{array} $ | h _{FE} | 40 70 100 60 30 | _ | - | | |
| | age | V _{CE(sat)} – 0.2 – 0.3 | | | | |
| $\begin{array}{l} Base-Emitter \; Saturation \; Voltage \\ (I_{C}=10 \; mAdc, \; I_{B}=1.0 \; mAdc) \\ (I_{C}=50 \; mAdc, \; I_{B}=5.0 \; mAdc) \end{array}$ | V _{BE(sat)} | 0.65 - | 0.85 0.95 | Vdc | | |
| SMALL-SIGNAL CHARACTERIS | STICS | | • | • | • | |
| Current-Gain - Bandwidth Produ | f _T | 200 | - | MHz | | |
| Output Capacitance (V _{CB} = 5.0 Vo | C _{obo} | - | 4.0 | pF | | |
| Input Capacitance (V _{EB} = 0.5 Vdc | C _{ibo} | - | 8.0 | pF | | |
| Noise Figure (V _{CE} = 5.0 Vdc, I_C = | NF | - | 5.0 | dB | | |
| SWITCHING CHARACTERISTIC | S | | | | | |
| Delay Time | $(V_{CC} = 3.0 \text{ Vdc}, V_{BE} = -0.5 \text{ Vdc})$ | t _d | - | 35 | | |
| Rise Time | (I _C = 10 mAdc, I _{B1} = 1.0 mAdc) | t _r | - | 35 | ns | |
| Storage Time | $(V_{CC} = 3.0 \text{ Vdc}, I_C = 10 \text{ mAdc})$ | t _s – | | 275 | | |
| all Time (I _{B1} = I _{B2} = 1.0 mAdc) | | t _f | _ | 50 | ns | |

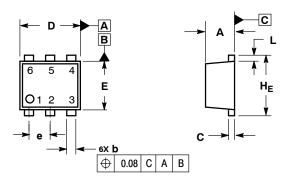
0.28 400 $I_{\rm C}/I_{\rm B} = 10$ 150°C (5.0 V) V_{CE(sat)} = 150°C 350 hFE, DC CURRENT GAIN (V) 300 150°C (1.0 V) | | | ||||| 25°C (5.0 V) 250 200 25°C (1.0 V) -55°C 1.1.1.1111 25°C 150 55°C (5.0 V) -55°C (1.0 V) 100 50 0 0.03 0.0001 0.001 0.01 0.1 0.0001 0.001 0.01 0.1 1 1 I_C, COLLECTOR CURRENT (A) I_C, COLLECTOR CURRENT (A) Figure 2. DC Current Gain vs. Collector Current Figure 1. Collector Emitter Saturation Voltage vs. **Collector Current**

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PACKAGE DIMENSIONS

SOT-963 CASE 527AD-01 ISSUE B



NOTES:

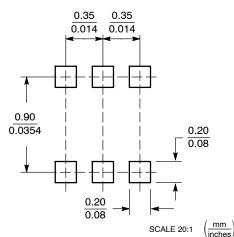
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

2. CONTROLLING DIMENSION: MILLIMETERS

 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

| | MILLIMETERS | | | INCHES | | | |
|-----|-------------|------|------|-----------|-------|-------|--|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX | |
| Α | 0.34 | 0.37 | 0.40 | | | | |
| b | 0.10 | 0.15 | 0.20 | 0.004 | 0.006 | 0.008 | |
| С | 0.07 | 0.12 | 0.17 | 0.003 | 0.005 | 0.007 | |
| D | 0.95 | 1.00 | 1.05 | 0.037 | 0.039 | 0.041 | |
| Е | 0.75 | 0.80 | 0.85 | 0.03 | 0.032 | 0.034 | |
| е | 0.35 BSC | | | 0.014 BSC | | | |
| L | 0.05 | 0.10 | 0.15 | 0.002 | 0.004 | 0.006 | |
| ΗE | 0.95 | 1.00 | 1.05 | 0.037 | 0.039 | 0.041 | |
| | | | | | | | |

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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